



NOTES:

1. MATERIAL:

1.1 HOUSING: THERMOPLASTIC, HIGH TEMP., UL94V-0; COLOR:BLACK.

1.2 CONTACT: COPPER ALLOY

1.3 SHELL: COPPER ALLOY

2. FINISH:

2.1 CONTACT:

50u" MIN. NICKEL UNDERPLATING OVERALL.

1:1~3u" GOLD ON CONTACT FOR LEAD FREE

T:10u" GOLD ON CONTACT FOR LEAD FREE

D:30u" GOLD ON CONTACT FOR LEAD FREE

B:5u" GOLD ON CONTACT FOR LEAD FREE

C:15u" GOLD ON CONTACT FOR LEAD FREE

2.2 SHELL:

50u" MIN. NICKEL UNDERPLATING OVERALL.

50~100u" MATT TIN PLATING ON SOLDER

3. SPEC. PLS. REFER TO PS-50398-XXXX

4. PACKAGE PLS. REFER TO 50406-XXXX-TRP/50406-XXXX-00-TRP

50406-XXXX-02-TRP

5. MATING CONNECTOR P/N:50407

6. PART NUMBER

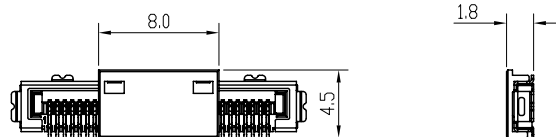
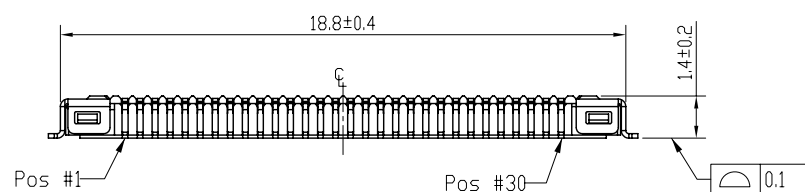
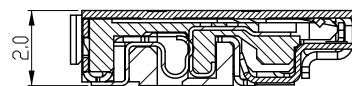
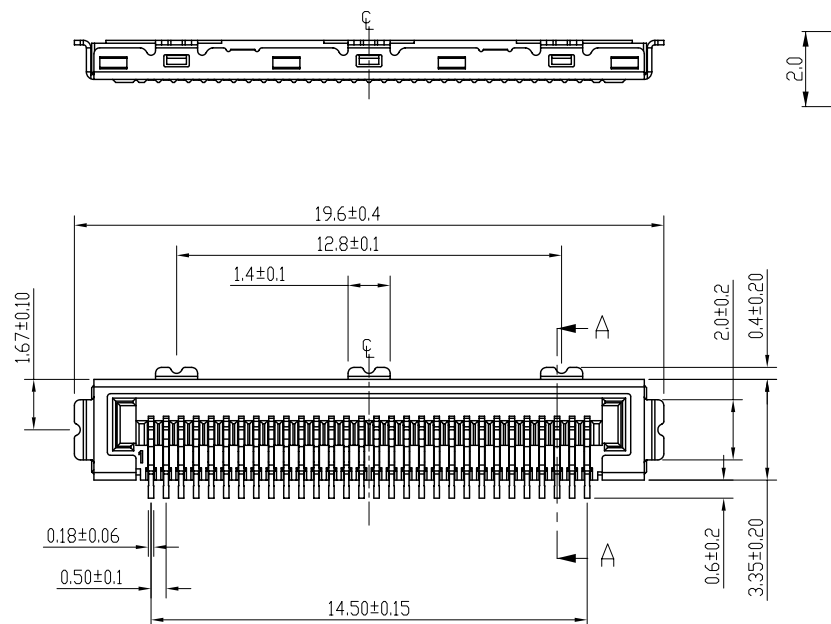
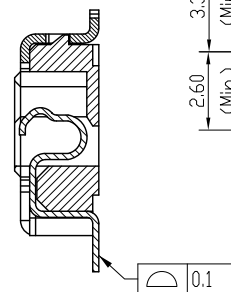
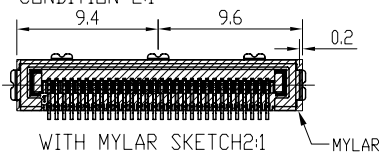
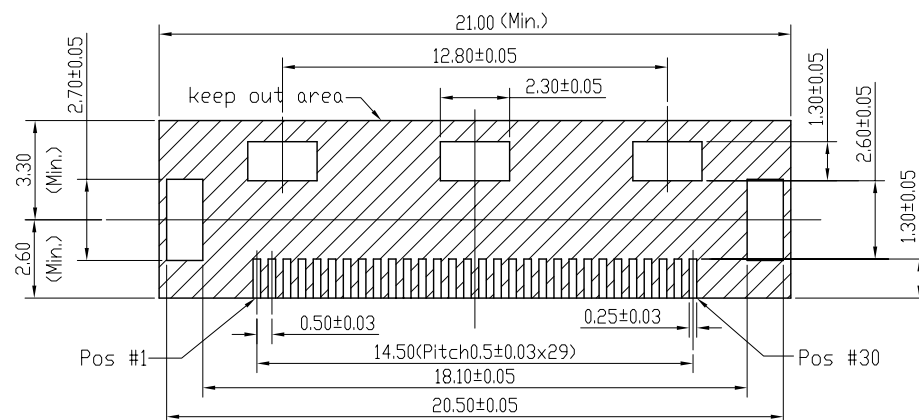
50406-XXX X X-XXX		XXX	PACKING	
030.30Pin		001	50406-XXXXCR-00(WITH MYLAR)	
			50406-XXXXCR(WITH COVER)	
		W01	50406-XXXXCR-02	
CONTACT PLATING				
1:1-3u" GOLD ON CONTACT FOR LEAD FREE				
T:10u" GOLD ON CONTACT FOR LEAD FREE				
D:30u" GOLD ON CONTACT FOR LEAD FREE				
B:5u" GOLD ON CONTACT FOR LEAD FREE				
C:15u" GOLD ON CONTACT FOR LEAD FREE				


PACKING

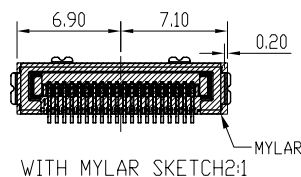
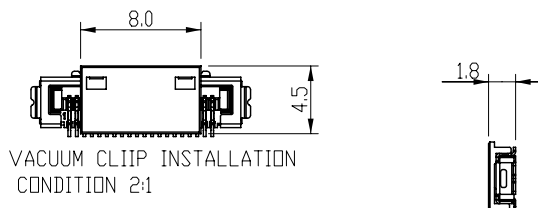
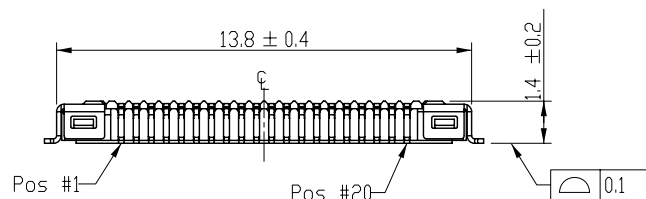
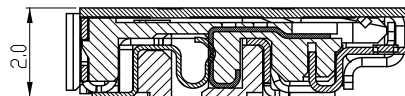
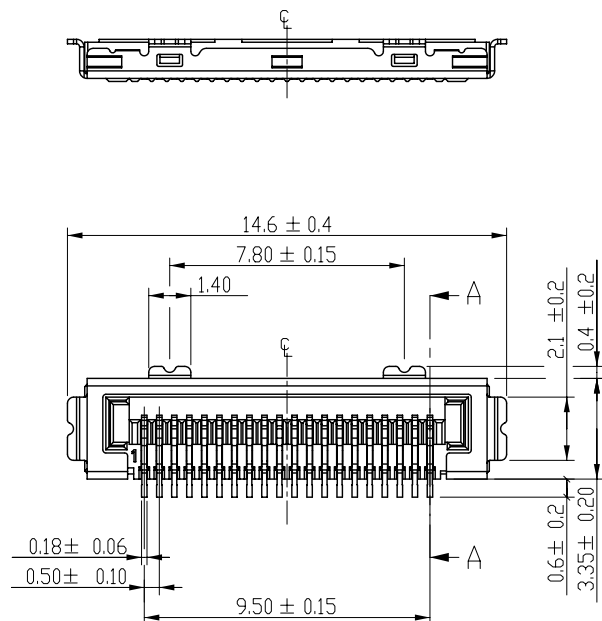
1.TUBE

7.TAPE REEL WITH COVER

4.TAPE REEL WITH MYLAR

VACUUM CLIP INSTALLATION
CONDITION 2:1Section A-A
Scale 8:1

一般公差 TOLERANCES X. ±0.5 XX ±0.15 .X ±0.25 .XXX ±0.1 ANGLES ±2°		宏致電子股份有限公司 Aces Electronics Co.,Ltd.					
檢驗尺寸標示 SYMBOLS ② ③ INDICATE CLASSIFICATION DIMENSION ② MARK IS CRITICAL DIM. ③ MARK IS MAJOR DIM.	品名 (TITLE) 0.5mm LVDS CONN.		製圖 (DR) 13/11/05 DAVID				
	圖號 (DWG NO.) 50406-XXXX-XXX		審核 (CHKD) JERRY				
			核准 (APPD) JASON				
	表面處理 (FINISH) _____		比例 (SCALE) 4:1	單位 (UNITS) mm		張數 (SHEET) 1 OF 3	SIZE A4



Section A-A
Scale 8:1

NOTES:

1. MATERIAL:

- 1.1 HOUSING: THERMOPLASTIC, HIGH TEMP., UL94V-0; COLOR:BLACK.
- 1.2 CONTACT: COPPER ALLOY
- 1.3 SHELL: COPPER ALLOY

2. FINISH:

2.1 CONTACT:

- 50u" MIN. NICKEL UNDERPLATING OVERALL.
- 1:1~3u" GOLD ON CONTACT FOR LEAD FREE
- T:10u" GOLD ON CONTACT FOR LEAD FREE
- D:30u" GOLD ON CONTACT FOR LEAD FREE
- B:5u" GOLD ON CONTACT FOR LEAD FREE
- C:15u" GOLD ON CONTACT FOR LEAD FREE

2.2 SHELL:

- 50u" MIN. NICKEL UNDERPLATING OVERALL.
- 50~100u" MATT TIN PLATING ON SOLDER

3. SPEC. PLS. REFER TO PS-50398-XXXX

4. PACKAGE PLS. REFER TO 50406-XXXX-TRP/50406-XXXX-02-TRP 50406-XXXX-04-TRP

5. MATING CONNECTOR P/N:50407

6. PART NUMBER

50406-XXX X X-XXX

020.20Pin

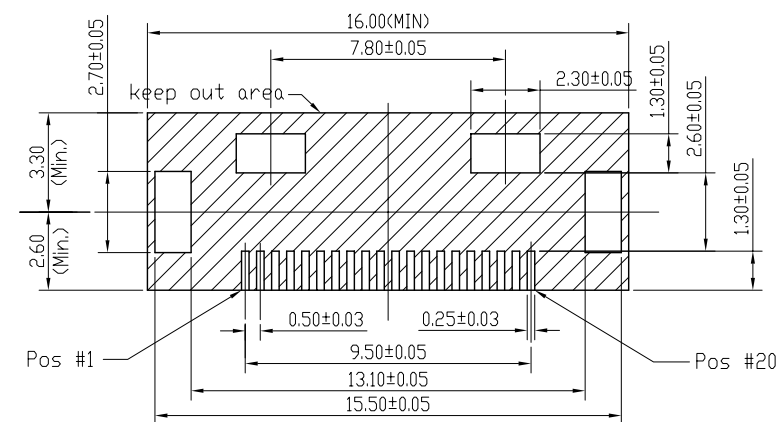
XXX	PACKING
001	50406-XXXX
W01	50406-XXXX-02
AT1	50406-XXXX-04

PACKING

- 1.TUBE
- 7.TAPE REEL WITH COVER
- 4.TAPE REEL WITH MYLAR

CONTACT PLATING

- 1:1~3u" GOLD ON CONTACT FOR LEAD FREE
- T:10u" GOLD ON CONTACT FOR LEAD FREE
- D:30u" GOLD ON CONTACT FOR LEAD FREE
- B:5u" GOLD ON CONTACT FOR LEAD FREE
- C:15u" GOLD ON CONTACT FOR LEAD FREE



一般公差 TOLERANCES X. ±0.5 XX ±0.15 X ±0.25 .XXX ±0.1 ANGLES ±2°		宏致電子股份有限公司 Aces Electronics Co.,Ltd.			
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表面處理 (FINISH)		比例 (SCALE) 4:1	單位 (UNITS) mm	張數 (SHEET) 2 OF 3	SIZE A4



NOTES:

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B:5u" GOLD ON CONTACT FOR LEAD FREE

C:15u" GOLD ON CONTACT FOR LEAD FREE

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50u" MIN. NICKEL UNDERPLATING OVERALL.

50~100u" MATT TIN PLATING ON SOLDER

3. SPEC. PLS. REFER TO PS-50398-XXXXX

4. PACKAGE PLS. REFER TO 50406-XXXXX-TRP/50406-XXXXX-02-TRP

5. MATING CONNECTOR P/N:50407

6. PART NUMBER

50406-XXX X X-XXX

040:40Pin
PACKING
1.TUBE
7.TAPE REEL WITH COVER
4.TAPE REEL WITH MYLAR

XXX	PACKING
001	50406-XXXXCR
W01	50406-XXXXCR-02

CONTACT PLATING

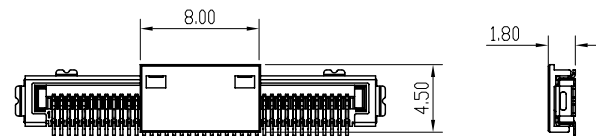
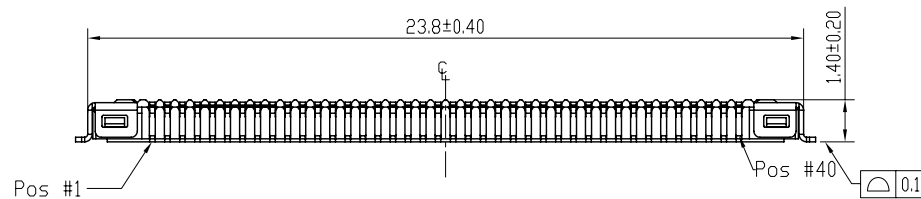
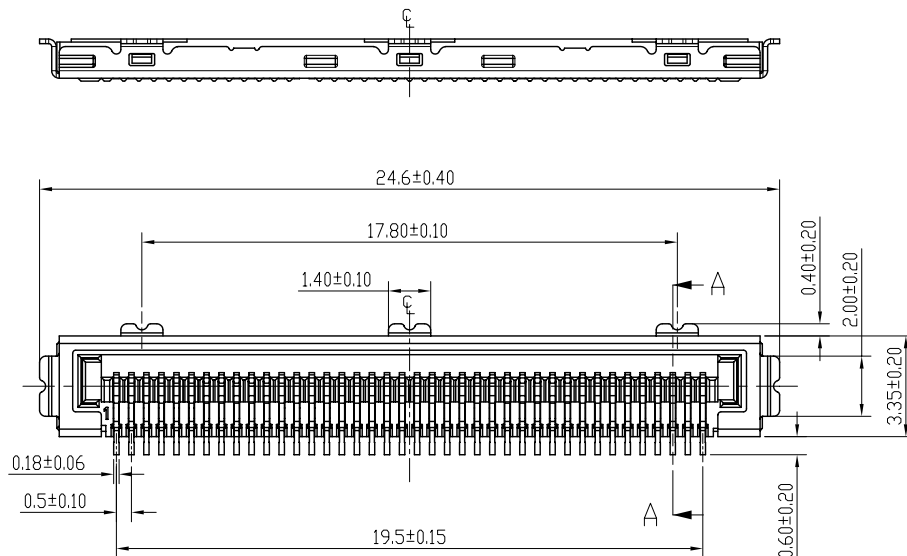
1:1~3u" GOLD ON CONTACT FOR LEAD FREE

T:10u" GOLD ON CONTACT FOR LEAD FREE

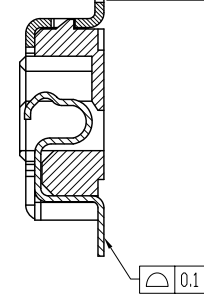
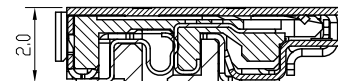
D:30u" GOLD ON CONTACT FOR LEAD FREE

B:5u" GOLD ON CONTACT FOR LEAD FREE

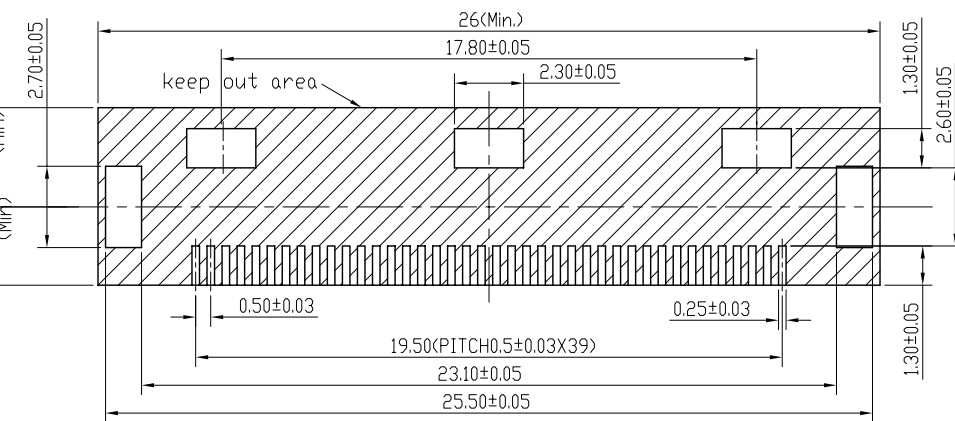
C:15u" GOLD ON CONTACT FOR LEAD FREE



VACUUM CLIP INSTALLATION
CONDITION 2:1



SECTION B-B
SCALE 8:1



一般公差 TOLERANCES X. ±0.5 XX ±0.15 X ±0.25 XXX ±0.1 ANGLES ±2°		宏致電子股份有限公司 Aces Electronics Co.,Ltd.			
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① MARK IS CRITICAL DIM. ② MARK IS MAJOR DIM.		圖號 (DWG NO.) 50406-XXXXX-XXX		審核 (CHKD) JERRY	
表面處理 (FINISH)		比例 (SCALE) 4:1		核准 (APPD) JASON	
		單位 (UNITS) mm		張數 (SHEET) 3 OF 3	
				SIZE A4	
				REV G	